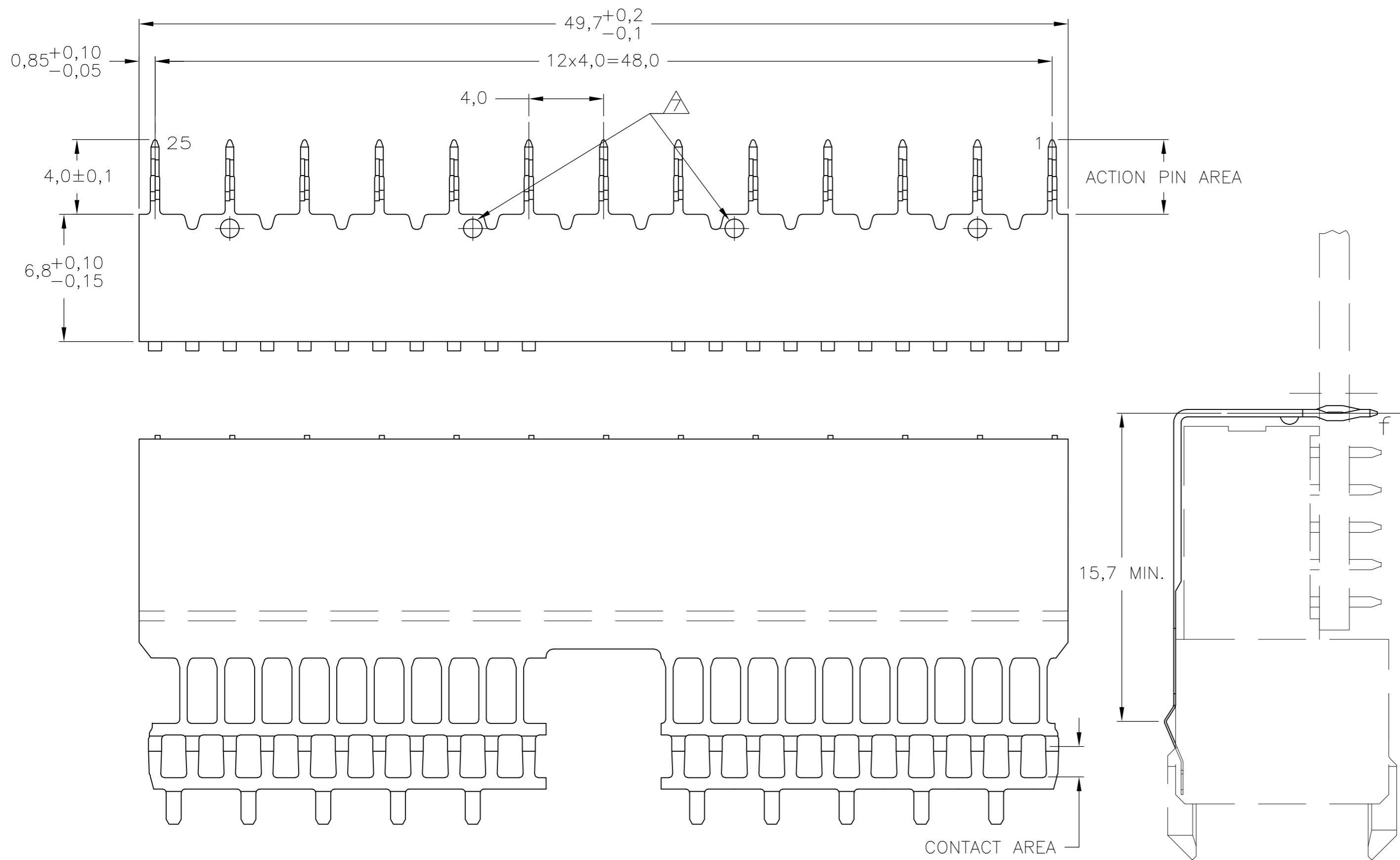


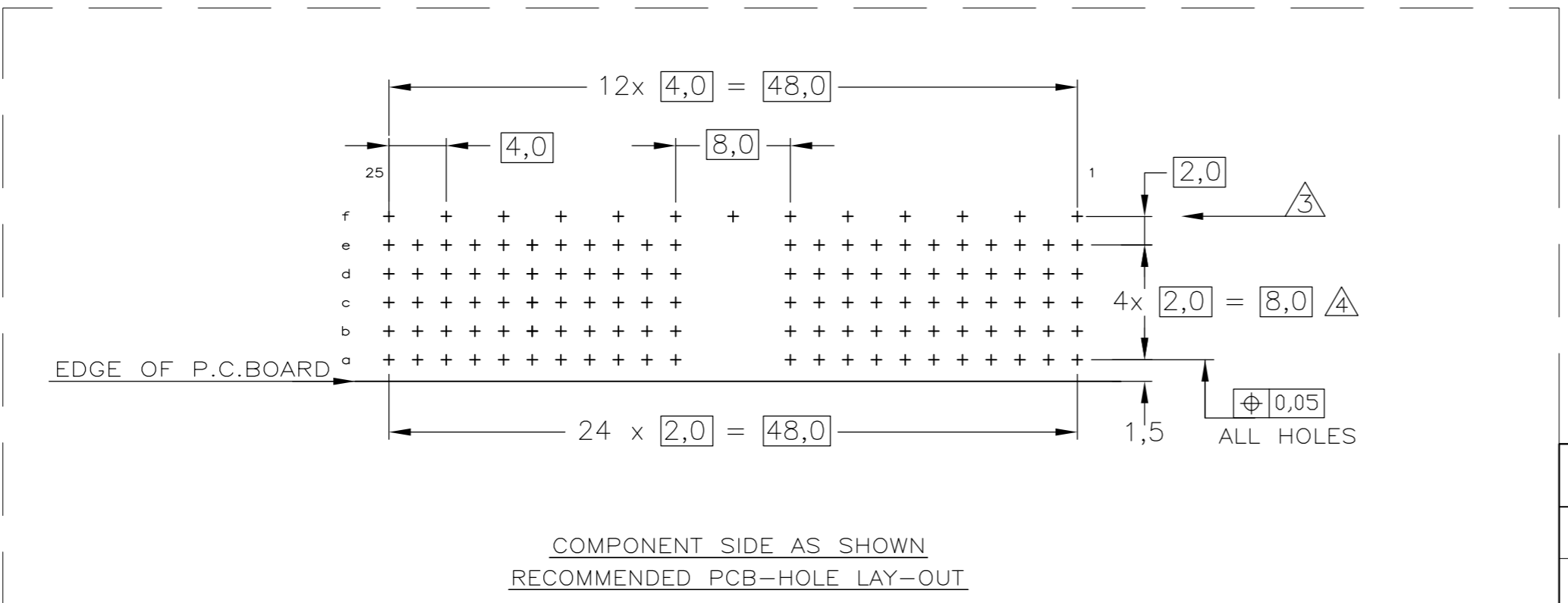
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Loc		DIST		REVISIONS			
P	LTR	DESCRIPTION		DATE	DWN	APVD	
	K	REVISED PER ECO-13-015151		16DEC2013	FL	FY	



**NOTES:**

- ⚠ GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1,27µm NICKEL MIN.AND ACTION PIN: 0,5µm TIN-LEAD MIN. FOR PLATING OF MATING SURFACES SEE PERFORMANCE LEVEL SHOWN IN PART NUMBER TABLE.
- ⚠ MATERIAL; PHOSPHORBRONZE.
- ⚠ ROW "f" 13 PLATED THROUGH HOLES FOR UPPERSHIELD
- ⚠ HOLE PATTERN FOR FEMALE CONNECTOR TYPE A 110 PLATED-THROUGH HOLES AT 2x2mm SQUARE GRID
- ⚠ SHIELDS LUBRICATED WITH BELLCORE APPROVED LUBRICANT. TECHNICAL REF: TR-NWT-001217 ISSUE 1, SEPT. 1992.
- ⚠ GENERAL PLATING SPECIFICATION: UNDERPLATING (ENTIRE CONTACT): 1,27µm NICKEL MIN.AND ACTION PIN: 0,5µm TIN-LEAD MIN. ASTM B579 60/40 FOR PLATING OF MATING SURFACES SEE PERFORMANCE LEVEL SHOWN IN PART NUMBER TABLE.
- ⚠ OPTIONAL DIMPLES AT DISCRETION OF DIE ENGINEER.
- ⚠ OBSOLETE PARTS: OBSOLETE CIS STREAMLINING PER D.RENAUD/D.SINISI
- ⚠ CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 2.
- ⚠ CONFORMS TO ALL TESTING ACCORDING IEC 61076-4-101 PERFORMANCE LEVEL 1.
- ⚠ CONNECTOR TESTED AND QUALIFIED AGAINST TELCORDIA GR-1217-CORE QUALITY LEVEL III,CENTRAL OFFICE APPLICATIONS.
- ⚠ 0.76µm MIN GOLD PLATING AT MATING SURFACE.
- ⚠ 1.27µm MIN GOLD PLATING AT MATING SURFACE.



P.C.B. HOLE DIM. ACTION PIN  
 FOR DETAILS SEE APPLICATION SPECIFICATION

FINISH	MATERIAL	PARTNUMBER
1, 9, 12	2	8-338107-4
1, 13	2	9-338107-3
6, 5, 11	2	9-338107-1
1, 5, 11	2	338107-9
1, 9	2	338107-2

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DWN	D. TRUREN	28-11-96
CHK	W/ v.d.HEIJDEN	28-11-96
APVD	F. v.KONINGSBRUGGE	-
PRODUCT SPEC	108-19082	
APPLICATION SPEC	114-19029	
WEIGHT	-	
CUSTOMER DRAWING		

**TE** TE Connectivity

Z-PACK 2mm HM  
 GROUND RETURN UPPER SHIELD  
 TYPE A

SIZE	A2	CAGE CODE	00779	DRAWING NO	C=338107	RESTRICTED TO	-
SCALE	5:1	SHEET	1 of 1	REV	K		